

74VHCT74A

Dual D-Type Flip-Flop with Preset and Clear

Features

- n High speed: $f_{MAX} = 160\text{MHz}$ (Typ.) at $T_A = 25^\circ\text{C}$
- n High noise immunity: $V_{IH} = 2.0\text{V}$, $V_{IL} = 0.8\text{V}$
- n Power down protection is provided on all inputs and outputs
- n Low power dissipation: $I_{CC} = 2\mu\text{A}$ (Max.) at $T_A = 25^\circ\text{C}$
- n Pin and function compatible with 74HCT74

General Description

The VHCT74A is an advanced high speed CMOS Dual D-Type Flip-Flop fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The signal level applied to the D INPUT is transferred to the Q OUTPUT during the positive going transition of the CK pulse. CLR and PR are independent of the CK and are accomplished by setting the appropriate input LOW.

Protection circuits ensure that 0V to 7V can be applied to the input pins without regard to the supply voltage and to the output pins with $V_{CC} = 0\text{V}$. These circuits prevent device destruction due to mismatched supply and input/output voltages. This device can be used to interface 3V to 5V systems and two supply systems such as battery backup.

Ordering Information

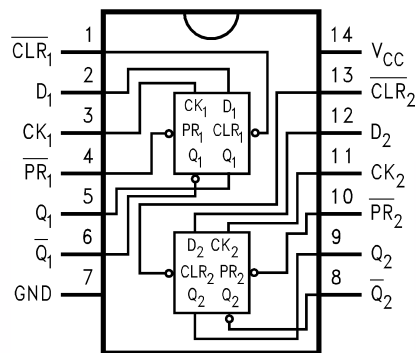
Order Number	Package Number	Package Description
74VHCT74AM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHCT74ASJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHCT74AMTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

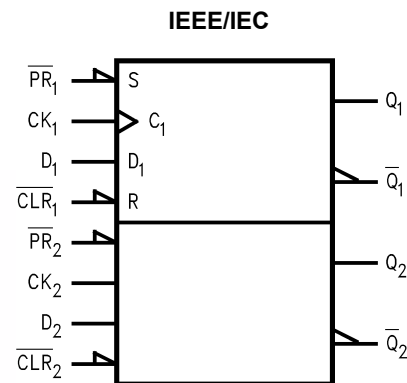


All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagram



Logic Symbol



Pin Description

Pin Names	Description
D ₁ , D ₂	Data Inputs
CK ₁ , CK ₂	Clock Pulse Inputs
CLR ₁ , CLR ₂	Direct Clear Inputs
PR ₁ , PR ₂	Direct Preset Inputs
Q ₁ , Q ₁ \bar , Q ₂ , Q ₂ \bar	Outputs

Truth Table

Inputs				Outputs		Function
CLR	PR	D	CK	Q	Q \bar	
L	H	X	X	L	H	Clear
H	L	X	X	H	L	Preset
L	L	X	X	H	H	
H	H	L	\nearrow	L	H	
H	H	H	\nearrow	H	L	
H	H	X	\sim	Q _n	Q _n	No Change

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	−0.5V to +7.0V
V_{IN}	DC Input Voltage	−0.5V to +7.0V
V_{OUT}	DC Output Voltage Note 1 Note 2	−0.5V to $V_{CC} + 0.5V$ −0.5V to 7.0V
I_{IK}	Input Diode Current	−20mA
I_{OK}	Output Diode Current ⁽³⁾	±20mA
I_{OUT}	DC Output Current	±25mA
I_{CC}	DC V_{CC} /GND Current	±50mA
T_{STG}	Storage Temperature	−65°C to +150°C
T_L	Lead Temperature (Soldering, 10 seconds)	260°C

Recommended Operating Conditions⁽⁴⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	4.5V to +5.5V
V_{IN}	Input Voltage	0V to +5.5V
V_{OUT}	Output Voltage Note 1 Note 2	0V to V_{CC} 0V to 5.5V
T_{OPR}	Operating Temperature	−40°C to +85°C
t_r, t_f	Input Rise and Fall Time $V_{CC} = 5.0V \pm 0.5V$	0ns/V ~ 20ns/V

Notes:

1. HIGH or LOW state. I_{OUT} absolute maximum rating must be observed.
2. $V_{CC} = 0V$.
3. $V_{OUT} < GND$, $V_{OUT} > V_{CC}$ (Outputs Active).
4. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = 25°C			T _A = -40°C to +85°C		Units
				Min.	Typ.	Max.	Min.	Max.	
V _{IH}	HIGH Level Input Voltage	4.5		2.0			2.0		V
		5.5		2.0			2.0		
V _{IL}	LOW Level Input Voltage	4.5				0.8		0.8	V
		5.5				0.8		0.8	
V _{OH}	HIGH Level Output Voltage	4.5	V _{IN} = V _{IH} or V _{IL}	4.40	4.50		4.40		V
		4.5		3.94			3.80		
V _{OL}	LOW Level Output Voltage	4.5	V _{IN} = V _{IH} or V _{IL}		0.0	0.1		0.1	V
		4.5				0.36		0.44	
I _{IN}	Input Leakage Current	0–5.5	V _{IN} = 5.5V or GND			±0.1		±1.0	μA
I _{CC}	Quiescent Supply Current	5.5	V _{IN} = V _{CC} or GND			2.0		20.0	μA
I _{CCT}	Maximum I _{CC} /Input	5.5	V _{IN} = 3.4V, Other Inputs = V _{CC} or GND			1.35		1.50	mA
I _{OFF}	Output Leakage Current (Power Down State)	0.0	V _{OUT} = 5.5V			+0.5		+5.0	μA

AC Electrical Characteristics

Symbol	Parameter	V _{CC} (V) ⁽⁵⁾	Conditions	T _A = 25°C			T _A = -40°C to +85°C		Units
				Min.	Typ.	Max.	Min.	Max.	
f _{MAX}	Maximum Clock Frequency	5.0	C _L = 15pF	100	160		80		MHz
		5.0	C _L = 50pF	80	140		65		
t _{PLH} , t _{PHL}	Propagation Delay Time (CK-Q, \bar{Q})	5.0	C _L = 15pF		5.8	7.8	1.0	9.0	ns
		5.0	C _L = 50pF		6.3	8.8	1.0	10.0	
t _{PLH} , t _{PHL}	Propagation Delay Time (CLR, \overline{PR} -Q, \bar{Q})	5.0	C _L = 15pF		7.6	10.4	1.0	12.0	ns
		5.0	C _L = 50pF		8.1	11.4	1.0	13.0	
C _{IN}	Input Capacitance		V _{CC} = Open		4	10		10	pF
C _{PD}	Power Dissipation Capacitance		⁽⁶⁾		24				pF

Notes:

5. V_{CC} is 5.0 ± 0.5V

6. C_{PD} is defined as the value of internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:

$$I_{CC} (\text{Opr.}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 2 \text{ (per flip-flop).}$$

AC Operating Requirements

Symbol	Parameter	V _{CC} (V)	T _A = 25°C		T _A = -40°C to +85°C	Units
			Typ.	Guaranteed Minimum		
t _W (L), t _W (H)	Minimum Pulse Width (CK)	5.0 ± 0.5		5.0	5.0	ns
t _W (L)	Minimum Pulse Width (CL _R , PR)	5.0 ± 0.5		5.0	5.0	ns
t _S	Minimum Setup Time	5.0 ± 0.5		5.0	5.0	ns
t _H	Minimum Hold Time	5.0 ± 0.5		0	0	ns
t _{REM}	Minimum Removal Time (CL _R , PR)	5.0 ± 0.5		3.5	3.5	ns

Physical Dimensions



Figure 1. 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow

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Physical Dimensions (Continued)

Figure 2. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

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Physical Dimensions (Continued)

Figure 3. 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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

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